Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20µs)	Ppk	100	Watts
Peak Pulse Current (tp = 8/20µs)	IPP	4	A
ESD per IEC 61000-4-2 (Air)[1] ESD per IEC 61000-4-2 (Contact)[1]	V_{ESD}	+/- 25 +/- 17	kV
Operating Temperature	T_J	-55 to +125	°C
Storage Temperature	T_{STG}	-55 to +150	°C

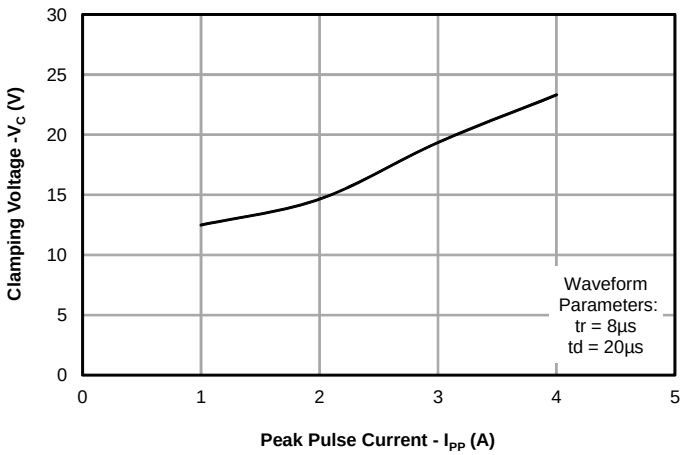
Electrical Characteristics (T=25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}				5	V
Reverse Breakdown Voltage	V_{BR}	I_t = 1mA	6	9.3	11	V
Reverse Leakage Current	I_R	V_{RWM} = 5V, T=25°C		0.005	0.100	µA
Clamping Voltage	V_C	I_{PP} = 1A, tp = 8/20µs			15	V
Clamping Voltage	V_C	I_{PP} = 4A, tp = 8/20µs			25	V
Dynamic Resistance[2, 3, 4]	R_D	tp = 100ns		0.90		Ohms
Junction Capacitance	C_j	V_R = 0V, f = 1MHz		0.35	0.50	pF

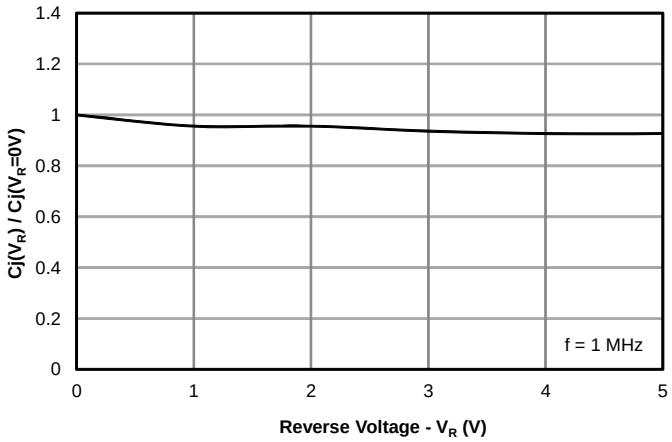
Notes
1)ESD gun return path connected to ESD ground reference plane.
2)Transmission Line Pulse Test (TLP) Settings: t_p = 100ns, t_r = 0.2ns, I_{TLP} and V_{TLP} averaging window: t_1 = 70ns to t_2 = 90ns.
3) Dynamic resistance calculated from I_{TLP} = 4A to I_{TLP} = 16A
4)Guaranteed by design. Not production tested

Typical Characteristics

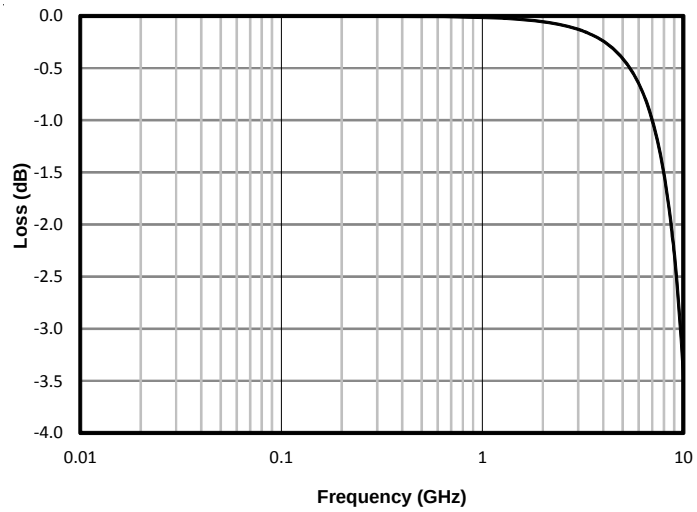
Clamping Voltage vs. Peak Pulse Current



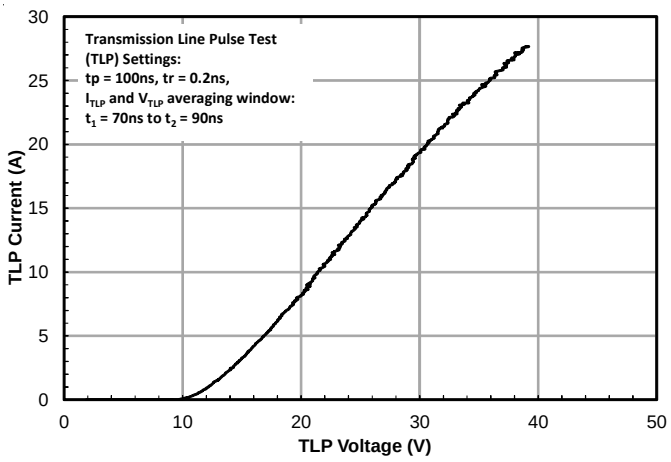
Typical Capacitance vs. Reverse Voltage



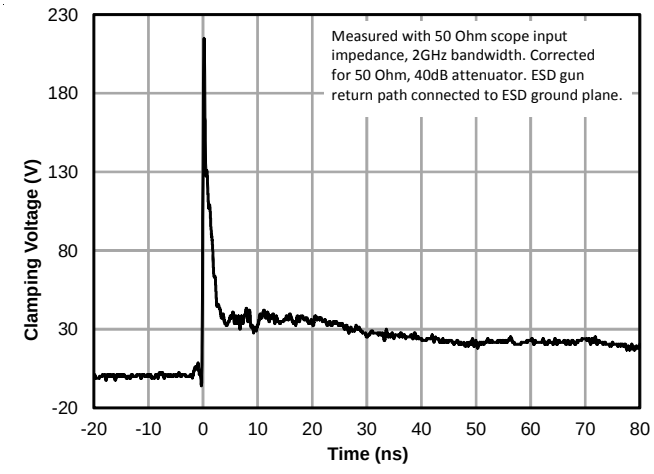
Typical Insertion Loss (S21)



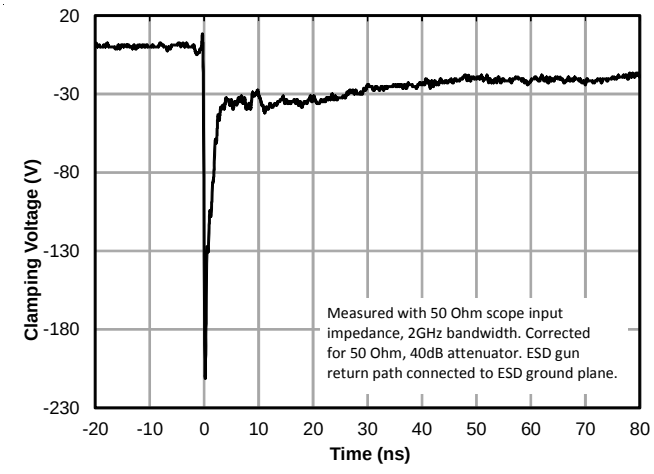
TLP Characteristic



ESD Clamping (+8kV Contact per IEC 61000-4-2)



ESD Clamping (-8kV Contact per IEC 61000-4-2)



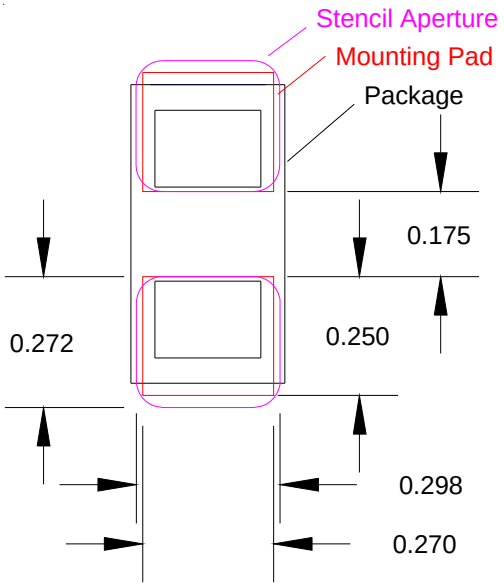
Applications Information

Assembly Guidelines

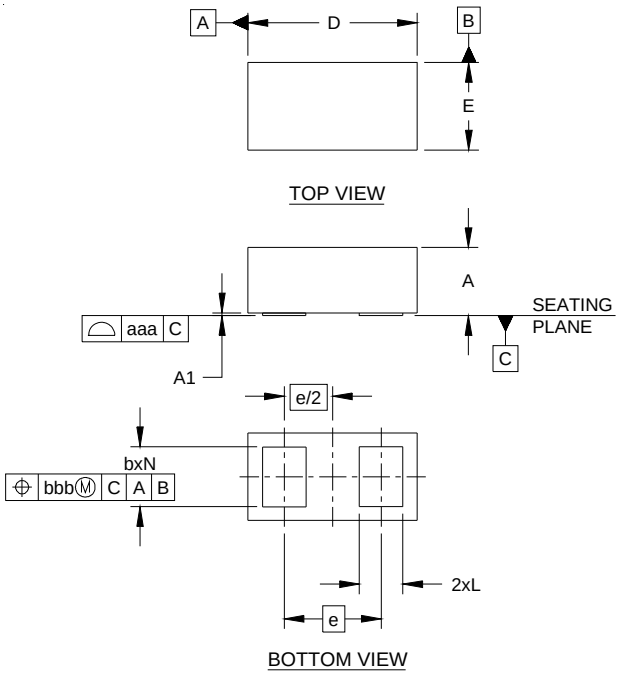
The small size of this device means that some care must be taken during the mounting process to insure reliable solder joint. The table below provides Semtech's recommended assembly guidelines for mounting this device. The figure at the right details Semtech's recommended aperture based on the below recommendations. Note that these are only recommendations and should serve only as a starting point for design since there are many factors that affect the assembly process. The exact manufacturing parameters will require some experimentation to get the desired solder application.

Assembly Parameter	Recommendation
Solder Stencil Design	Laser cut, Electro-polished
Aperture shape	Rectangular with rounded corners
Solder Stencil Thickness	0.100 mm (0.004")
Solder Paste Type	Type 4 size sphere or smaller
Solder Reflow Profile	Per JEDEC J-STD-020
PCB Solder Pad Design	Non-Solder mask defined
PCB Pad Finish	OSP OR NiAu

Recommended Mounting Pattern



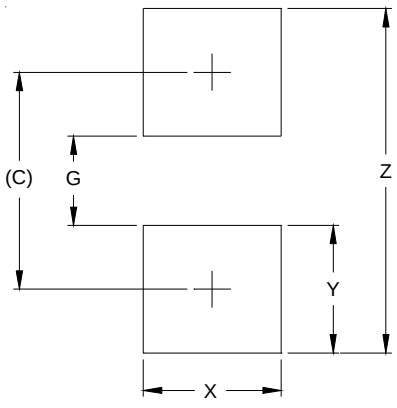
Outline Drawing - SLP0603P2X3



DIMENSIONS			
DIM	MILLIMETERS		
	MIN	NOM	MAX
A	0.235	0.25	0.265
A1	0.000	0.02	0.025
b	0.20	0.22	0.24
D	0.585	0.62	0.655
E	0.285	0.32	0.355
e	0.355 BSC		
L	0.14	0.16	0.18
N	2		
aaa	0.08		
bbb	0.10		

NOTES:
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).

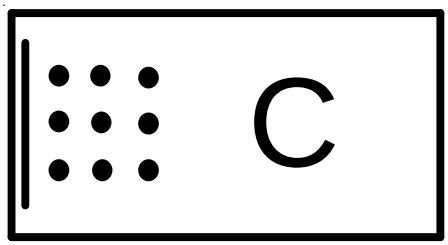
Land Pattern - SLP0603P2X3



DIMENSIONS	
DIM	MILLIMETERS
C	(0.425)
G	0.175
X	0.270
Y	0.250
Z	0.675

NOTES:
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

Marking Code



Notes:
1)Dots represent date code matrix

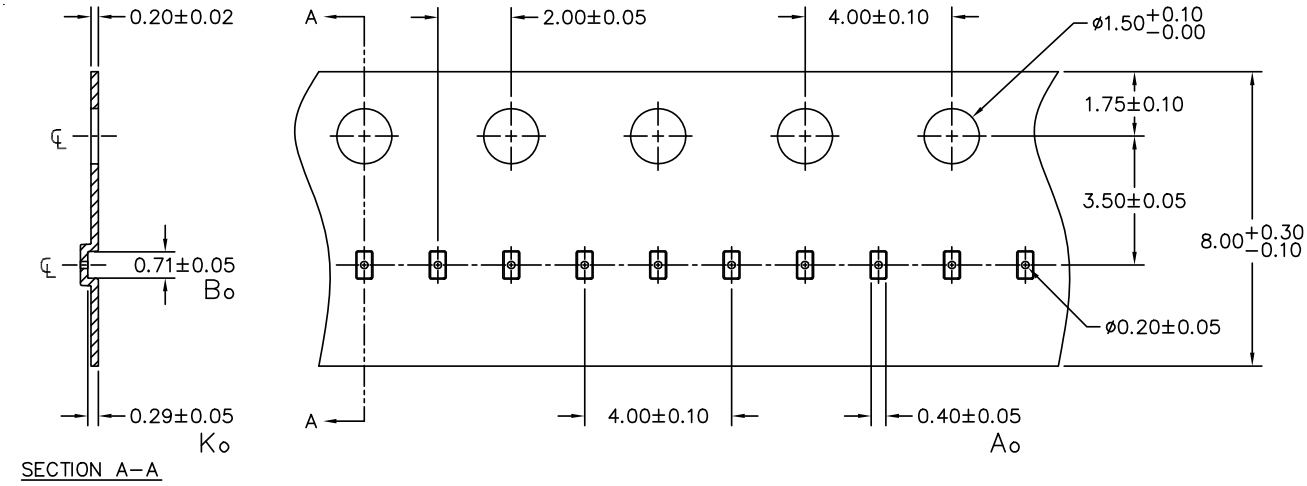
Ordering Information

Ordering Number	Qty per Reel	Carrier Tape	Reel Size	Comments
RClamp0521Z.TNT	10,000	Plastic	7 Inch	Not Recommended for New Designs
RClamp0521Z.TFT	15,000	Paper	7 Inch	

RailClamp and RClamp are trademarks of Semtech Corporation.

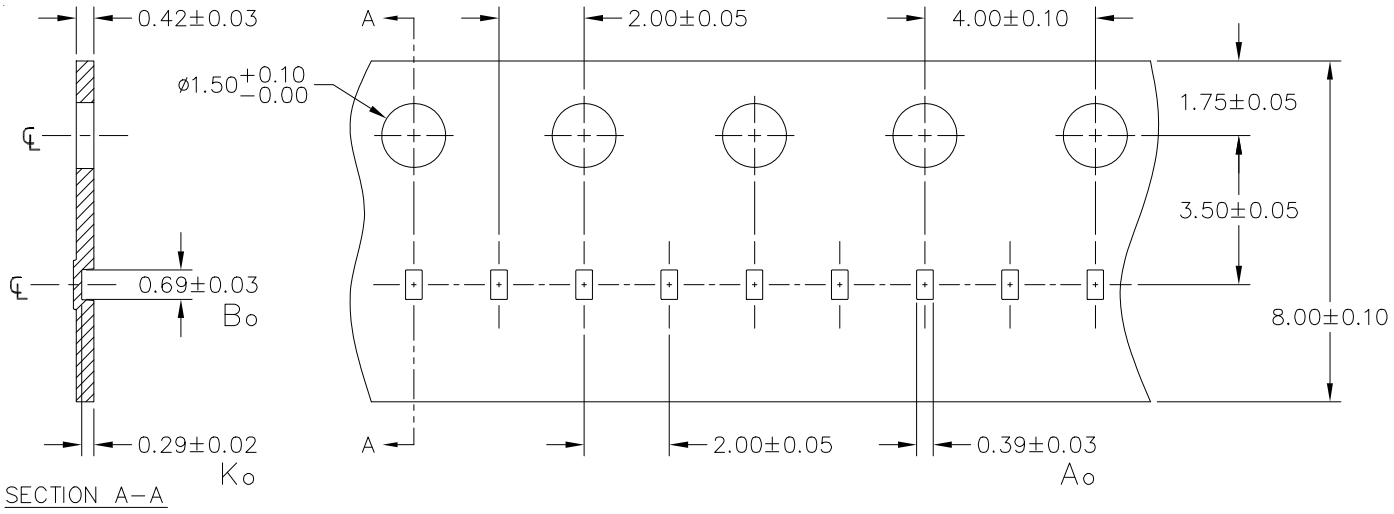
Carrier Tape Specification

Plastic Tape



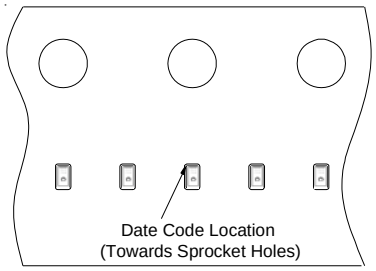
NOTES: 1.) ALL DIMENSIONS IN MILLIMETERS UNLESS OTHERWISE SPECIFIED.

Paper Tape



Note: All dimensions in mm unless otherwise specified

Device Orientation in Tape



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